



PATENT

UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/647,297 Group Art Unit: 1794
Filing Date: August 26, 2003 Examiner: Hai Vo
Applicants: Hyun HUH et al.
Title: POLISHING PAD CONTAINING EMBEDDED LIQUID
MICROELEMENTS AND METHOD OF
MANUFACTURING THE SAME
Attorney Docket: 47881-000003/US

Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314
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May 19, 2008

SUPPLEMENTAL AMENDMENT UNDER 35 U.S.C. §1.116

Sir:

In response to the Advisory Action mailed April 11, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended one (1) month to May 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims begins on page 2 of this Amendment.

Remarks begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	14	-	31	=	0
Independent	1	-	3	=	0